

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Aaron Kaplan	kaplana@lunainnovations.com	Luna Innovations	USA
Abhinav Saxena	abhinav.saxena@nasa.gov	NASA Ames Research Center	USA
Ajit Mal	ajit@ucla.edu	UCLA	USA
Alessio Medda	medda.alessio@gmail.com	Georgia Tech Research Institute	USA
Alex Pun	apun@memsic.com	Memsic, Inc.	USA
Alexander Holst	a.holst@ibmb.tu-bs.de	University of Braunschweig	Germany
Alexander Tessler	alexander.tessler-1@nasa.gov	NASA-LARC	USA
Alexis Mendez	amendez@micronoptics.com	Micron Optics, Inc.	USA
Alfred Gnadinger	alfred@albido.com	Albido Corporation	USA
Alfredo Guemes	alfredo.guemes@upm.es	UPM	Spain
Ali Abedi	abedi@eece.maine.edu	University of Maine	USA
Ali Abu Yousef	abuyousef_ali@yahoo.com	University of Texas Austin	USA
Ali Hurson	hurson@mst.edu	Missouri University of Science and Technology	USA
Amin Karami	karami@umich.edu	University of Michigan	USA
Amir Mosavi	amosavi@scsolutions.com	SC Solutions, Inc	USA
An-Dien Nguyen	a.d.nguyen@lgrinc.com	Los Gatos Research	USA
Andrea Del Grosso	delgrosso@dicat.unige.it	University of Genoa	Italy
Andrei Zagrai	azagrai@nmt.edu	New Mexico Tech	USA
Andrew Nguyen	ahn@efreecom.com	Efree Commerce	USA
Andrew Peterson	apeterson@micronoptics.com	Micron Optics	USA
Andrew Vechart	Andrew.Vechart@honeywell.com	Honeywell	USA
Andrew Zimmerman	andy@civionics.com	Civionics, LLC	USA
Angel Alicea	angelalicea@gmail.com	University of Puerto Rico	USA
Anindya Ghoshal	anindya.ghoshal.civ@mail.mil	US ARL	USA
Ann Patterson-Hine	ANN.PATTERSON-HINE@NASA.GOV	NASA Ames Research Center	USA
Anne Kiremidjian	ask@stanford.edu	Stanford University	USA
Anthony Croxford	a.j.croxford@bristol.ac.uk	University of Bristol	UK
Antoine Clement	clement@insa-toulouse.fr	Université de Toulouse	France
Antonio Concilio	a.concilio@cira.it	The Italian Aerospace Research Centre	Italy
Aping Zhang	zhangap@zju.edu.cn	Optilab, LLC	USA
Ariel Irizarry	ariel.irizarry@upr.edu	University of Puerto Rico	USA
Arkadiusz Zak	arek@imp.gda.pl	IFFM PASci	Poland
Arnaud Deraemaeker	aderaema@ulb.ac.be	ULB - BATir	Belgium
Artur Hanc	Alicja@energocontrol.pl	EC Electronics	Poland

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Artur Hanc	Alicja@energocontrol.pl	EC Electronics	Poland
Ashok Srivastava	Ashok.N.Srivastava@nasa.gov	NASA Ames Research Center	USA
Bahram Jalali	jalali@ucla.edu	UCLA	USA
Benjamin Grisso	benjamin.grisso@navy.mil	NSWC Carderock	USA
Benoit Kroely	benoit.kroely@advitam-group.com	ADVITAM	USA
Benoit Kroely	benoit.kroely@advitam-group.com	ADVITAM	USA
Bernard Laskowski	laskowski@anatom.com	Anatom Incorporated	USA
Bernd Frankenstein	birgit.rueger@izfp-d.fraunhofer.de	Fraunhofer Institute for Non-Destructive Testing	Germany
Betty Glass	betty.c.glass@lmco.com	Lockheed Martin Space Systems	USA
Bianca Hennings	bianca.hennings@hsu-hh.de	Helmut-Schmidt-University	Germany
Bill X. Yu	xxy21@case.edu	Case Western Reserve University	USA
Bin Lin	LINBIN@cec.sc.edu	University of South Carolina	USA
Bin Shi	shibin@nju.edu.cn	Nanjing University	China
Bin Xu	binxu@hnu.edu.cn	Hunan University	China
Blanco Pinzon Carlos Eduardo	CARLOS.BLANCO@ECOPETROL.com.co	Instituto Colombiano del Petroleo	Colombia
Bong-Hwan Koh	bkoh@dongguk.edu	Dongguk University	South Korea
Brad Gilliland	bradley.gilliland@ge.com	GE Inspection Technologies	USA
Branko Glisic	bglisic@princeton.edu	Princeton University	USA
Brent Roeder	broeder@mcqinc.com	McQ Inc.	USA
Bruce Barker	bruce.c.barker@usace.army.mil	US Army Corps of Engineers ERDC	USA
Byungseok Yoo	bsyoo@umd.edu	University of Maryland	USA
Carl Palmer	carl.palmer@impact-tek.com	Impact Technologies, LLC	USA
Carl Palmer	carl.palmer@impact-tek.com	Impact Technologies, LLC	USA
Carlo Rainieri	carlo.rainieri@unimol.it	University of Molise	Italy
Carlos Enol Garcia-Gonzalez	cegarcia@aero.upm.es	UPM	Spain
Carlos Miguel-Giraldo	Carlos.DeMiguel@airbus.com	Airbus	Spain
Cedric Jacob	cjacob@udel.edu	University of Delaware	USA
Chao Wang	chaowang@ee.ucla.edu	UCLA	USA
Chao-Nan Xu	cn-xu@aist.go.jp	AIST	Japan
Charles Buynak	charles.buynak@wpafb.af.mil	Air Force Research Lab	USA
Charles DeVore	cdevore@usc.edu	University of Southern California	USA
Charles Farrar	farrar@lanl.gov	INST-OFF	USA
Cheng Yang	yang@imr.mb.uni-siegen.de	University of Siegen	Germany
Cheng Zhong Ng	ncz@ust.hk	Hong Kong University	Hong Kong

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Chin-Hsiung Loh	lohc0220@ccms.ntu.edu.tw	National Taiwan University	Taiwan
Chris Davis	christopher.l.davis@boeing.com	Boeing Research and Technology	USA
Christian Dürager	christian.duerager@empa.ch	EMPA	Switzerland
Christian Grosse	grosse@tum.de	Technische Universität	Germany
Christian Stolz	Christian.Stolz@cassidian.com	EADS Deutschland GmbH	Germany
Christine Schubert Kabban	christine.schubertkabban@afit.edu	Air Force Institute of Technology	USA
Christopher Allen	vincent.le-cam@lcpc.fr	Booz Allen Hamilton	USA
Christopher Stull	stull@lanl.gov	Los Alamos National Laboratory	USA
Chudzikiewicz Andrzej	achwp@wp.pl	Warsaw University of Technology	Poland
Chul-Min Yeum	chulminy@gmail.com	KAIST	South Korea
Claudio Nucera	cnucera@ucsd.edu	UCSD	USA
Claus-Peter Fritzen	fritzen@imr.mb.uni-siegen.de	University of Siegen	Germany
Cliff Lissenden	lissenden@psu.edu	Penn State	USA
Colin Haynes	cmhaynes@ucsd.edu	UCSD	USA
Constantin Papadas	papadas@isd.gr	ISD SA	Greece
Constanze Schilder	constanze.schilder@bam.de	BAM Federal Institute for Materials Research and Testing	Germany
Courtney Peckens	cpeckens@umich.edu	University of Michigan	USA
Daichi Wada	daichi_wd@giso.t.u-tokyo.ac.jp	The University of Tokyo	Japan
Dan Inman	DanInman@umich.edu	University of Michigan	USA
Dan Zhang	zhangdan@nju.edu.cn	Nanjing University	China
Danhui Dan	dandanhui@tongji.edu.cn	Tongji University	China
Daniel Gagar	d.gagar@cranfield.ac.uk	Cranfield University IVHM Centre	UK
Daniel Osmont	osmont@onera.fr	Onera	France
Daniela Dragomirescu	daniela@laas.fr	University of Toulouse, LAAS-CNRS	France
Daniele Zonta	daniele.zonta@unitn.it	University of Trento	Italy
Danny Parker	dparker@one.ducommun.com	Miltec Research & Technology	USA
Dapeng Zhu	zhudp01@hotmail.com	Georgia Institute of Technology	USA
David Eickholt	dave.eickholt@parker.com	Parker Aerospace	USA
David Falck	dfalck@scsolutions.com	SC Solutions	USA
David Mascarenas	dmascarenas@lanl.gov	INST-OFF	USA
David Potter	david.potter@ni.com	National Instruments	USA
David Zhang	zhang@acellent.com	Acellent Technologies, Inc.	USA
Dean McNeill	mcneill@ee.umanitoba.ca	University of Manitoba	Canada
Dennis Roach	dproach@sandia.gov	Sandia National Labs	USA

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Derek Doyle	derek.doyle@kirtland.af.mil	Air Force Research Laboratory	USA
Didem Ozevin	dozevin@uic.edu	University of Illinois at Chicago	USA
Diego Burgos	diego.tibaduiza@upc.edu	Universitat Politecnica de Catalunya	Spain
Dietrich Hartmann	hartus@gmx.net	Ruhr-University Bochum	Germany
Dinesh Patel	dpatel@memsic.com	Memsic, Inc.	USA
Dirk Soeffker	soeffker@uni-due.de	University of Duisburg-Essen	Germany
Don Olechowski	dono@metisdesign.com	Metis Design Corporation	USA
Douglas Adams	deadams@purdue.edu	Purdue University	USA
Dryver Huston	dryver.huston@uvm.edu	University of Vermont	USA
Dunne Jim	james.p.dunne@boeing.com	Boeing	USA
Eduardo Bauzer Medeiros	bauzer@demec.ufmg.br	Universidade Federal de Minas Gerais	Brazil
Elizabeth Cross	e.j.cross@sheffield.ac.uk	University of Sheffield	UK
Eloi Figueiredo	eloifigueiredo@fe.ucp.pt	Univeridade do Porto - Faculdade de Engenharia	Portugal
Enrique Medina	enrique.a.medina@saic.com	Science Applications International Corporation	USA
Eric Bergles	tdaniel@bayspec.com	BaySpec, Inc.	USA
Eric Flynn	eflynn@metisdesign.com	Metis Design Corporation	USA
Eric Hernandez	eric.hernandez@uvm.edu	University of Vermont	USA
Eric Lindgren	Eric.Lindgren@wpafb.af.mil	Air Force Research Lab	USA
Eric Swenson	eric.swenson@afit.edu	AFIT	USA
Eric Whitfield	Eric_Whitfield@lansmont.com	Lansmont Corporation	USA
Erik Thostenson	thosten@udel.edu	University of Delaware	USA
Etienne Constable	Etienne.Constable@roctest.com	Roctest	USA
Fabio Casciati	fabio@dipmec.unipv.it	University of Pavia	Italy
Fabio Semperlotti	fsemperl@nd.edu	University of Notre Dame	USA
Fabrizio Ricci	fabricci@unina.it	University of Naples	Italy
Fady Barsoum	Fady.Barsoum@erau.edu	Embry-Riddle Aeronautical University	USA
Fahit Gharibnezhad	fahit.gharibnezhad@upc.edu	Technical University of Cataluna	Spain
Fan Wu	wufan@stanfordalumni.org	Shanghai Jiao Tong University	China
Fariba Abazarsa	abazarsa@gmail.com	UCLA	USA
Felix Wu	felix.wu@nist.gov	NIST	USA
Fernando Dotta	fernando.dotta@embraer.com.br	EMBRAER S.A.	Brazil
Fikret Catbas	catbas@ucf.edu	University of Central Florida	USA
Frederic Cegla	f.cegla@imperial.ac.uk	Imperial College	UK
Fuh-Gwo Yuan	yuan@ncsu.edu	North Carolina State University	USA

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Gaëlle Pouget	gaelle.pouget@constellium.com	Constellium CRV	France
Gang Yan	yangang@nuaa.edu.cn	Nanjing University	China
Gaurav Pandey	gpandey@udel.edu	University of Delaware	USA
Gennadii Boldyrev	g-boldyrev@geotek.ru	Geotek Ltd	Russia
Gerard Gallo	grard@udel.edu	University of Delaware	USA
Glauco Humberto Gomes	gluaco.gomes@embraer.com.br	Embraer S.A.	Brazil
Gustavo Dias	nfsalgado@critical-materials.com	Critical Materials, SA	Portugal
Haiying Huang	huang@uta.edu	University of Texas Arlington	USA
Hamza Boukabache	hboukaba@laas.fr	LAAS-CNRS	France
Helga Allmer	allmer@vce.at	VCE	Austria
Helge Pfeiffer	helge.pfeiffer@mtm.kuleuven.be	Katholieke Universiteit Leuven	Belgium
Helmut Wenzel	wenzel@vce.at	VCE	Austria
Henning Jung	henning.jung@uni-siegen.de	University of Siegen	Germany
Henry Hung	henry.hung@optilab.com	Optilab, LLC	USA
Henry Kroker	s.mcmeekin@smsystems.com.au	Structural Monitoring Systems Ltd	Australia
Hesham Azzam	hesham.azzam@hahnspring.co.uk	HAHN Spring Ltd	UK
Hideaki Murayama	murayama@sys.t.u-tokyo.ac.jp	The University of Tokyo	Japan
Hidehiko Banshoya	banshouya@smart.k.u-tokyo.ac.jp	University of Tokyo	Japan
Hiroshi Tsuda	hiroshi-tsuda@aist.go.jp	AIST	Japan
Honghu Zhu	zhz@nju.edu.cn	Nanjing University	China
Hoon Sohn	hoonsohn@kaist.ac.kr	KAIST	South Korea
Houssam Toutanji	toutanji@cee.uah.edu	University of Alabama in Huntsville	USA
Houssein Nasser	houssein_nasser@hotmail.com	Centre de REcherche	Luxembourg
Huaxiang Yang	hyang@crosslinkusa.com	Crosslink	USA
Iddo Kressel	ikressel@iai.co.il	Israel Aerospace Industries	Israel
Ignacio Gonzalez-Requena	ignaciof.gonzalez@upm.es	UPM	Spain
Ignacio Perez de Leon	ignacio.perez1@navy.mil	Office of Naval Research	USA
Irshad Mohammad	irshad.mohammad@mavs.uta.edu	University of Texas at Arlington	USA
Irving Oppenheim	ijo@cmu.edu	Carnegie Mellon University	USA
Ivan Bartoli	ib77@drexel.edu	Drexel University	USA
Jake Galbreath	jhgalbreath@microstrain.com	MicroStrain, Inc	USA
James Ayers	james.t.ayers.civ@mail.mil	US Army Research Lab	USA
James Crowder	JACrowder@raytheon.com	Raytheon Company	USA
James King	jim.king@meggitt.com	Meggitt	USA

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Jan Achenbach	achenbach@northwestern.edu	NU Center for Quality Engineering	USA
Jean-Marie Dilhac	dilhac@laas.fr	LAAS-CNRS	France
Jean-Michel Roche	jean-michel.roche@onera.fr	Onera	France
Jeff Bagwell	jeff.bagwell@us.army.mil	AMCOM CBM	USA
Jennifer Michaels	jennifer.michaels@ece.gatech.edu	Georgia Institute of Technology	USA
Jeong Na	jna@ewi.org	EWI	USA
Jeong-Beom Ihn	jeong-beom.ihn@boeing.com	Boeing Research and Technology	USA
Jeremiah Fasl	JDFasl@mail.utexas.edu	University of Texas Austin	USA
Jerome Lynch	jerlynch@umich.edu	University of Michigan	USA
Jerome Pinsonnault	jerome.pinsonnault@aero.bombardier.com	Bombardier Aerospace	Canada
Jerry Huang	jerry.q.huang@boeing.com	Boeing Research and Technology	USA
Jian Zhang	jianzhang.civil@gmail.com	Southeast University	USA
Jianguo Yu	yu22@cec.sc.edu	University of South Carolina	USA
Jianmin Qu	j-qu@northwestern.edu	Northwestern University	USA
Jim McFeat	jim.mcfeat@baesystems.com	BAE Systems	UK
Jimmy Miller	jimmy.l.miller@nasa.gov	NASA	USA
Jindrich Finda	Jindrich.Finda@Honeywell.com	Honeywell International	Czech Republic
Jinkyu JK Yang	jkyang@gmail.com	University of South Carolina	USA
Jinying Zhu	jyzhu@mail.utexas.edu	University of Texas Austin	USA
Joaquin Rams	joaquin.rams@urjc.es	Rey Juan University	Spain
Jochen Kurz	jochen.kurz@izfp.fraunhofer.de	Fraunhofer-Institut IZFP	Germany
Joel Harley	jharley@andrew.cmu.edu	Carnegie Mellon University	USA
John Aldrin	aldrin@computationaltools.com	Computational Tools	USA
John Powell	john.powell@optilab.com	Optilab, LLC	USA
John Powell	john.powell@optilab.com	Optilab, LLC	USA
John Aldrin	aldrin@computationaltools.com	Computational Tools	USA
Jonathan White	jonwhit@sandia.gov	Sandia National Labs	USA
Joong Sun-Hwang	jason.hwang@nlr.nl	National Aerospace Laboratory	The Netherlands
José Celaya	jose.r.celaya@nasa.gov	NASA Ames Research Center	USA
Josef Küng	jkueng@faw.jku.at	Johannes Kepler University Linz	Austria
Joseph Yutzy	josephyutzy@gmail.com	Purdue University	USA
Joshua Cummins	joshua.cummins@navy.mil	NAVAIR	USA
Jozue Vieira Filho	jozue@dee.feis.unesp.br	UNESP	Brazil
Jui-Fang Kuo	ray.kuo@exxonmobil.com	ExxonMobil Upstream Research	USA

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Julien Tremblay	jtremblay@itflabs.com	ITF Labs Inc	Canada
Juliette Marin	jmarin@bridge.t.u-tokyo.ac.jp	The University of Tokyo	Japan
Júlio Viana	nfsalgado@critical-materials.com	Critical Materials, SA	Portugal
Jung-Ryul Lee	leejrr@jbnu.ac.kr	Chonbuk National University	South Korea
Junliang Tao	jxt290@case.edu	Case Western Reserve University	USA
Kai Goebel	kai.goebel@nasa.gov	NASA Ames Research Center	USA
Kalyan Nadella	nkalyan@umich.edu	University of Michigan	USA
Kay Smarsly	smarsly@stanford.edu	Stanford University	USA
Kazuki Tachibana	tachibana@giso.t.u-tokyo.ac.jp	The University of Tokyo	Japan
Keith Worden	k.worden@sheffield.ac.uk	University of Sheffield	UK
Kenneth Loh	kjloh@ucdavis.edu	UC Davis	USA
Kenny Gross	kenny.gross@oracle.com	Oracle Corp	USA
Kirk Grimmelsman	kgrimmel@uark.edu	University of Arkansas	USA
Klaas Vogel	klaas.vogel@elsys-instruments.com	Elsys Instruments, LLC	USA
Kohei Takahashi	TakahashK5@uae.subaru-fhi.co.jp	Fuji Heavy Industries	Japan
Krzysztof Holak	holak@agh.edu.pl	AGH Cracow	Poland
Lance Richards	Lance.Richards-1@nasa.gov	NASA - Dryden Space Flight Center	USA
Le Cam Vincent	vincent.le-cam@lcpc.fr	IFSTTAR-LCPC	France
LeRoy Fitzwater	LeRoy.M.Fitzwater@boeing.com	The Boeing Company	USA
Lesley Brealey	milson@acracontrol.com	ACRA CONTROL	USA
Liang Dong	ld19821213@126.com	Nanjing University	China
Lieske Uwe	birgit.rueger@izfp-d.fraunhofer.de	Fraunhofer Institute for Non-Destructive Testing	Germany
Limin Zhou	mmlmzhou@inet.polyu.edu.hk	The Hong Kong Polytechnic University	Hong Kong
Lingyuu Yu	yu3@cec.sc.edu	University of South Carolina	USA
Liu Mei	meiliu@z3.keio.jp	Keio University	Japan
Livia Zarnescu	liviaz@stanford.edu	IFOS	USA
Lotfollah Pahlavan	l.pahlavan@tudelft.nl	TU Delft	The Netherlands
Lothar Gaul	gaul@iam.uni-stuttgart.de	University of Stuttgart	Germany
Lou'i Al-Shrouf	loui.alshrouf@uni-due.de	University of Duisburg-Essen	Germany
Lucia Faravelli	fabio@dipmec.unipv.it	University of Pavia	Italy
Luis Avendano-Valencia	ldavendanov@gmail.com	University of Patras	Greece
Luis Eduardo Mujica	luis.eduardo.mujica@upc.edu	Universitat Politècnica de Catalunya	Spain
Luís F. Ramos	lramos@civil.uminho.pt	University of Minho	Italy
Luis Santos	luis.santos@embraer.com.br	Embraer S.A.	Brazil

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Lukasz Ambrozinski	ambrozin@agh.edu.pl	AGH-UST	Poland
Maciej Radzienski	mradzienski@imp.gda.pl	IFFM PASci	Poland
Magdi Essawy	magdi.essawy@goodrich.com	Goodrich S&IS	USA
Mannur Sundaresan	mannur@ncat.edu	NC A&T State University	USA
Mansur Celebi	mcelebi@hho.edu.tr	Turkish Air Force Academy	Turkey
Marcin Sokolowski	msokolowski@ecel.pl	EC Electronics	Poland
Marco Gherlone	marco.gherlone@polito.it		Italy
Mariana Melo Mota	mota.mariana@hotmail.com	Delft University of Technology	The Netherlands
Mariusz Szwedo	szwedo@agh.edu.pl	AGH University of Science and Technology	Poland
Mark Oxley	mark.oxley@afit.edu	Air Force Institute of Technology	USA
Mark Pappakostas	mark.pappakostas@acellent.com	Acellent Technologies, Inc.	USA
Martin DeSimio	Martin.DeSimio@udri.udayton.edu	University of Dayton	USA
Masahiro Kurata	masak@umich.edu	University of Michigan	USA
Masoud Rabiei	masoud.rabiei@impact-tek.com	Impact Technologies, LLC	USA
Mateusz Rosiek	rosiek@agh.edu.pl	AGH University of Science and Technology	Poland
Mathieu Lastapis	mathieu.lastapis@laas.fr	LAAS-CNRS	France
Matteo Pozzi	matteo.pozzi@berkeley.edu	UC Berkeley	USA
Matthew Davies	Matthew.Davies@udri.udayton.edu	University of Dayton	USA
Matthew Jones	mjones@one.ducommun.com	Miltec Research & Technology	USA
Matthew Leonard	matthew.leonard@wpafb.af.mil	AFRL/RBSI	USA
Matthew Potrawski	mpotraws@purdue.edu	Purdue University	USA
Matthew Smith	mds002@ucsd.edu	UCSD	USA
Matthew Watson	matthew.watson@impact-tek.com	Impact Technologies, LLC	USA
Matthew Whelan	mwhelan3@uncc.edu	UNC Charlotte	USA
Matthias Buderath	matthias.buderath@cassidian.com	Cassidian	Germany
Matthieu Gresil	matthieu@engr.sc.edu	University of South Carolina	USA
Mian Wang	wangmianTHU@126.com	Tsinghua University	China
Michael Döhler	michael.dohler@inria.fr	INRIA	France
Michael Kolling	michael.kolling@airbus.com	Airbus	Germany
Michael Moles	michael.moles@olympusndt.com	Olympus NDT	USA
Michael Quarry	mquarry@epri.com	Electric Power Research Institute	USA
Michael Reinstein	m@archetype.com	Structural Monitoring Systems Ltd	USA
Michael Scheerer	michael.scheerer@aac-research.at	Aerospace & Advanced Composites GmbH	Austria
Michael Todd	mdtodd@ucsd.edu	UCSD	USA

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Michael Vospernig	michael.vospernig@bernard-ing.com	RED Bernard / TU Vienna	Austria
Micheal Coatney	michael.d.coatney.civ@mail.mil	US Army Research Lab	USA
Miguel Torres-Arredondo	torres@zess.uni-siegen.de	University of Siegen	Germany
Mike Grimmer	mgrimmer@memsic.com	Memsic, Inc.	USA
Mikio Yoshida	yoshida@sokeizai.or.jp	RIMCOF	Japan
Milan Dvorak	milan.dvorak@fs.cvut.cz	Czech Technical University in Prague	Czech Republic
Milan Ruzicka	milan.ruzicka@fs.cvut.cz	Czech Technical University in Prague	Czech Republic
Ming Hei Cheng	MMHCHENG@CALTECH.EDU	Caltech	USA
Ming Wang	mi.wang@neu.edu	Northeastern University	USA
Mingyu Lu	08900426r@polyu.edu.hk	The Hong Kong Polytechnic University	Hong Kong
Minjing Liu	liumj@dlut.edu.cn	The Hong Kong Polytechnic University	China
Mohamed Sultan	drthariq@yahoo.com	University Putra Malaysia	Malaysia
Mohammad Azarbajani	azarbajanim@utpa.edu	Univ. of Texas Pan American	USA
Mohammad Jalalpour	mj95@unm.edu	University of New Mexico	USA
Mohammad Jamal Ahmad	m.jamal-ahmad08@imperial.ac.uk	AWE	UK
Mohammad Reza Jahanshahi	jahansha@usc.edu	University of Southern California	USA
Moritz Häckell	m.haeckell@isd.uni-hanover.de	LUH Institute of Structural Analysis	Germany
Moshe Tur	tur@post.tau.ac.il	Tel-Aviv University	Israel
Mourad Zeghal	zeghal@rpi.edu	Rensselaer Polytechnic Institute	USA
Mulugeta Haile	mulugeta.a.haile.civ@mail.mil	US ARL	USA
Mustafa Ugur Aridogan	uaridogan@ku.edu.tr	Koc University	Turkey
Nam Phan	charlene.ives@navy.mil	NAVAIR	USA
Nam-Sik Kim	nskim@pusan.ac.kr	Pusan National University	South Korea
Nate Bordick	nate.bordick@us.army.mil	US Army AATD	USA
Nehemiah Mabry	Nehemiahj20@yahoo.com	NC State University	USA
Neil Hoult	neil.hoult@gmail.com	Queen's University	Canada
Nick Plescia	nplescia@avensys.com	Avensys Inc.	Canada
Nicolas Quaegebeur	nicolas.quaegebeur@usherbrooke.ca	Université de sherbrooke	Canada
Nitesh Gupta	ngupta@nal.res.in	National Aerospace Laboratory	India
Nozomi Saito	nozomi_saito@mhi.co.jp	Mitsubishi Heavy Industries, LTD.	Japan
Okenwa Okoli	okoli@eng.fsu.edu	HPMI - Florida State University	USA
Patrice Masson	Patrice.Masson@USherbrooke.ca	Université de Sherbrooke	Canada
Paul Swindell	paul.swindell@faa.gov	FAA	USA
Paul Ziehl	ziehl@enr.sc.edu	U. South Carolina	USA

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Paulo Anchieta	anchieta@embraer.com.br	Embraer S.A.	Brazil
Pawel Kudela	pk@imp.gda.pl	IFFM PASci	Poland
Pawel Packo	pawel.packo@agh.edu.pl	AGH-UST	Poland
Peter Foote	peter.foote@baesystems.com	BAE Systems	UK
Peter Hagedorn	hagedorn@dyn.tu-darmstadt.de	TU Darmstadt	Germany
Peter Kung	peter@qpscom.com	QPS Photonics Inc	Canada
Philip Gregor	phil_gregor@arstechsales.com	Elsys Instruments, LLC	USA
Pia Sartor	pia.sartor@messier-dowty.com	Messier-Dowty	UK
Pierre Ferdinand	pierre.ferdinand@cea.fr	CEA	France
Pierre Stephan	pierre.stephan@edf.fr	EDF	France
Pierre-Claude Ostiguy	Pierre-Claude.Ostiguy@Usherbrooke.ca	Université de Sherbrooke	Canada
Piervincenzo Rizzo	pir3@pitt.edu	University of Pittsburgh	USA
Qiang Wang	qiangwang@cjlu.edu.cn	China Jiliang University	China
Qinian Qi	wzhang@inphenix.com	InPhenix, Inc.	USA
Radek Hedl	radek.hedl@honeywell.com	Honeywell International	Czech Republic
Rafik Hajrya	raf.hajrya@gmail.com	PIMM	France
Rakesh Kapania	rkapania@vt.edu	Virginia Polytechnic Institute	USA
Ramesh Sundaram	rameshs@nal.res.in	National Aerospace Laboratory	India
Ramil Mercado	rmercado@crosslinkusa.com	Crosslink	USA
Ranjan Vepa	r.vepa@qmul.ac.uk	Queen Mary, University of London	UK
Ray Ruichong Zhang	rzhang@mines.edu	Colorado School of Mines	USA
Raymond Brennan	raymond.e.brennan.civ@mail.mil	US Army Research Lab	USA
Ricardo Pinheiro Rulli	rrulli@embraer.com.br	Embraer S.A.	Brazil
Richard Black	rjb@ifos.com	IFOS	USA
Richard Evans	revansmgt@hotmail.com	Structural Monitoring Systems Ltd	USA
Richard Livingston	rliving1@umd.edu	University of Maryland	USA
Rob Barthorpe	r.j.barthorpe@sheffield.ac.uk	University of Sheffield	UK
Robert Owen	rowen@extremediagnosics.com	Extreme Diagnostics, inc.	USA
Roberto Dugnani	rdugnani@exponent.com	Exponent Failure Analysis Associates	USA
Roberto M. Finzi Neto	finzi@pq.cnpq.br	Federal University of Uberlandia	Brazil
Robin Plum	robin.plum@kit.edu	Karlsruhe Institute of Technology	Germany
Rocky Arnold	rarnold@exponent.com	Exponent, Inc.	USA
Rolf Lammering	rolf.lammering@hsu-hh.de	Helmut-Schmidt-University	Germany
Romain Montheard	romain.montheard@laas.fr	LAAS-CNRS	France

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Rongshuai Li	lrs0809@163.com	Keio University	Japan
Roy Mahapatra	droymahapatra@aero.iisc.ernet.in	Indian Institute of Science	India
Ruijiang Li	rli2@stanford.edu	Stanford University / Texas Tech	USA
Ryan Beardsley	ryan.beardsley@nottingham.ac.uk	University of Nottingham	UK
Ryan John	ryan.john@baesystems.com	Heriot-Watt University	UK
Ryan Maestri	rmaestri@uark.edu	University of Arkansas	USA
Sam Huang	ss_huang@yahoo.com	NASA Ames Research Center	USA
Sang Jun Lee	sangjunl@gmail.com	Georgia Institute of Technology	USA
Sauvik Banerjee	sauvik@civil.iitb.ac.in	IIT Bombay	India
Scott Ouellette	scott.ouellette4@gmail.com	UCSD	USA
Sean Oconnor	smotown1@gmail.com	University of Michigan	USA
Seth Kessler	skessler@metisdesign.com	Metis Design Corporation	USA
Syedfarid Ghahari	Ghahari@gmail.com	UCLA	USA
Shahab Torkamani	shahab@nmsu.edu	New Mexico State University	USA
Shamim Pakzad	pakzad@lehigh.edu	Lehigh University	USA
Shannon McKenzie	shannon.mckenzie@ge.com	GE Aviation	USA
Shawn Beard	sjb@acellent.com	Acellent Technologies, Inc.	USA
Shawn Brennan	shawn.brennan@goodrich.com	Goodrich Corporation	USA
Shenen Chen	schen12@uncc.edu	University of North Carolina at Charlotte	USA
Shuqin Ye	cesqye@polyu.edu.hk	Hong Kong Polytechnic University	Hong Kong
Silas Nesson	silas.nesson@navy.mil	NSWC Carderock	USA
Simone Manzato	simone.manzato@lmsintl.com	LMS International	Belgium
Simone Tancredi	fabricci@unina.it	University of Naples	Italy
Soon Duck Kwon	sdkwon@chonbuk.ac.kr	Chonbuk National University	South Korea
Spencer Graves	spencer.graves@structuremonitoring.com	Structure Inspection and Monitoring, Inc.	USA
SR Lin	SR.Lin@aero.org	The Aerospace Corporation	USA
Stephan Zerbst	s.zerbst@isd.uni-hannover.de	ISD Leibniz Universität Hannover	Germany
Stephen Pierce	s.g.pierce@eee.strath.ac.uk	University of Strathclyde	UK
Steve Galea	steve.galea@dsto.defence.gov.au	DSTO	Australia
Stuart Taylor	sgtaylor@lanl.gov	LANL	USA
Tadeusz Stepinski	ts@signal.uu.se	Uppsala University	Sweden
Tadeusz Uhl	tuhl@agh.edu.pl	University of Science and Technology AGH	Poland
Takahiro Fujiwara	tkfujiwara@acm.org	Hakodate National College of Technology	Japan
Ted Ooijsaar	t.h.ooijsaar@utwente.nl	University of Twente	The Netherlands

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Terrisa Duenas	tduenas@nextgenaero.com	NextGen Aeronautics	USA
Thomas Baca	tjbaca@sandia.gov	Sandia National Labs	USA
Thomas Michaels	thomas.michaels@ece.gatech.edu	Georgia Institute of Technology	USA
Thomas Sainthuille	thomas.sainthuille@univ-valenciennes.fr	IEMN-DOAE UMR CNRS	France
Tim Wank	twank@uark.edu	University of Arkansas	USA
Timothy Fallon	timothy.fallon@navy.mil	NAVAIR	USA
Toby Chandler	toby Chandler@gmail.com	Structural Monitoring Systems Ltd	USA
Todd Owens	cowens@afit.edu	Air Force Institute of Technology	USA
Tomasz Barszcz	tbarszcz@agh.edu.pl	AGH University of Science and Technology	Poland
Tomio Nakajima	t_nakajima@iic.ihc.co.jp	IHI Inspection & Instrumentation Co., Ltd	Japan
Tomohiko Hatada	hatada@kajima.com	Kajima Corporation	Japan
Treven Baker	treven.baker@us.army.mil	Aviation Applied Technology Directorate	USA
Tribikram Kundu	tkundu@email.arizona.edu	University of Arizona	USA
Troy Lundstrom	troy.lundstrom@gmail.com	The University of Massachusetts Lowell	USA
Tyler Arsenault	arsenatj@clarkson.edu	Clarkson University	USA
Tzu-Kang Lin	tklin@ntu.edu.tw	National Center for Research on Earthquake Engg.	Taiwan
Valery Godinez-Azcuaga	Valery.Godinez@mistrasgroup.com	Mistras Group Inc.	USA
Vanessa Heckman	heckman@caltech.edu	Caltech	USA
Vasyl Hafiychuk	vasyl.hafiychuk@nasa.gov	NASA Ames Research Center	USA
Vellaichamy Thiruvengadam	thiruspa@rediffmail.com	School of Planning and Architecture	India
Vladimir Grachev	dir@gmpg.ru	Grachev and Partners Ltd	Russia
Wei Zhang	wzhang@inphenix.com	InPhenix, Inc.	USA
Weislaw Ostachowicz	wieslaw@imp.gda.pl	IFFM PASci	Poland
Wenjia Liu	wenjial@mtu.edu	Michigan Tech	USA
Wenzhong Qu	qwz0803@yahoo.com.cn	Wuhan University	China
Wieslaw Staszewski	w.j.staszewski@sheffield.ac.uk	AGH University of Science and Technology	Poland
William Frazier	wgfrazier@gmail.com	Miltec Corp	USA
William Jacobs	william.jacobs@mech.kuleuven.be	K.U.Leuven	Belgium
Wingkong Chiu	wing.kong.chiu@monash.edu	Monash University	Australia
Xavier Chapeleau	xavier.chapeleau@ifsttar.fr	IFSTTAR	France
Xiaohua Yi	yixh@gatech.edu	Georgia Institute of Technology	USA
Xinlin Qing	qingxinlin@comac.cc	COMAC	China
Xu Hao	hao.ready.go@live.cn	The Hong Kong Polytechnic University	Hong Kong
Yan Esterkin	yestekin@redondooptics.com	Redondo Optics, Inc.	USA

<b>Registrant</b>	<b>E-mail ID</b>	<b>Affiliation</b>	<b>Country</b>
Yan Esterkin	yesterkin@redondooptics.com	Redondo Optics Inc	USA
Yan Niu	niu@imr.mb.uni-siegen.de	University of Siegen	Germany
Yang Liu	ly7628@hit.edu.cn	Harbin Institute of Technology	China
Yang Wang	yang.wang@ce.gatech.edu	Georgia Institute of Technology	USA
Yao Yao	yaoyao@princeton.edu	Princeton University	USA
Yasutoshi Nomura	y-nomura@fc.ritsumei.ac.jp	Ritsumeikan University	Japan
Yayu Hew	ya-yu.hew@mavs.uta.edu	University of Texas Arlington	USA
Yellapu Anjan	yellapu.anjan@optilab.com	Optilab, LLC	USA
Yihyan Lin	yihyan@uw.edu	University of Washington	USA
Ying Zhang	yzhang@gatech.edu	Georgia Institute of Technology	USA
Yi-Qing Ni	ceyqni@inet.polyu.edu.hk	Hong Kong Polytechnic University	Hong Kong
Yiska Goldfeld	yiska@tx.technion.ac.il	Technion - Israel Institute of Technology	Israel
Yoji Okabe	okabey@iis.u-tokyo.ac.jp	The University of Tokyo	Japan
Yong Huang	huangyong@hit.edu.cn	Harbin Institute of Technology	China
You Ling	you.ling@vanderbilt.edu	Vanderbilt University	USA
Young-Bin Park	ypark@unist.ac.kr	UNIST	South Korea
Yuan Liu	yuan.liu@ensam.eu	ARTS	France
Yujie Ying	yying@cmu.edu	Carnegie Mellon University	USA
Yuri Zadorozhny	yzadorozhny@optellios.com	Optellios	USA
Yusaku Ito	yusaku@smart.k.u-tokyo.ac.jp	University of Tokyo	Japan
Zhanjun Wu	wuzhj@dlut.edu.cn	Dalian University of Technology	China
Zheming Wu	wuzheming@gmail.com	Tsinghua University	China
Zhu Mao	zmao@ucsd.edu	UCSD	USA
Zili Li	Z.Li@tudelft.nl	Delft University of Technology	The Netherlands